Chip Beads (2518121217Y6)



Part Number: 2518121217Y6

MULTI- LAYER CHIP BEAD

Part Number System: Example 2512063017Y1

25	1206	301	7	Y	1	
Chip	Package	Impedance	Packaging	Material	Current Code	
Bead	Size	Code	Code	Code	0 < 1.0A	
Code	Code	300 A	6= Bulk Packed	Y = Standard Signal Speed	1 ≥1.0A <2.0A	
		7=	Taped and Reeled 7" Reel	Z = High Signal Speed	3 ≥3.0A <4.0A	
		8=	Taped and Reeled 13" Reel	H = GHz Speed	ETC	

Fair- Rite offers a broad selection of cost effective multi- layer chip beads to suppress conducted EMI signals. Chip beads can be used in an array of devices such as cellular phones, computers, laptops, pagers, etc. The small package sizes accommodate automated placements and allow for a dense packaging of circuit boards.

Chip Beads are available in standard, high and GHz signal speeds.

Recommended Soldering Profile

Packaging Options:

- All multi- layer chip beads are supplied taped and reeled, if required bulk packed chip beads can be provided.

The suggested land patterns are in accordance to the latest revision of IPC-7351.

Weight: 0.09 (g)

Packag	e Size:	: 1812 (4532	2)				
Dim	mm	mm tol	nor	ninal inch		inch misc	
А	1.5	±0.20	0.0	59		_	
В	3.2	±0.20	0.1	26			
С	4.5	±0.20	0.1	77		_	
D	0.7	±0.30	0.028			_	
Land P	atterns	5					
V W		W		Х	Y		Ζ
2.00 3.90			3.40	1	.90		
(0.079") (0.1		(0.154")	(0.154")		(0.134") (0		-

Reel Information						
Tape Width mm	Pitch mm	Parts 7" Reel	Parts 13" Reel	Parts 14" Reel		
12	8	1000	5000			

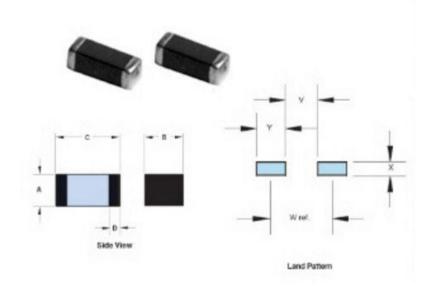


Chart Legend + Test frequency

Typical Impedance (Ω)					
50 MHz	93				
100 MHz^+	12	0 ± 25	%		
500 MHz	18	5			
1000 MHz^+	-				
Electrical Properties					
Max DCR (Ω)		0.02			
Max Curren (mA)	t	6000			

The impedance values listed are typical values. The nominal impedance with a +/-25% tolerance is specified for the + marked 100 MHz. Chip beads are measured for impedance on the HP 4291A and fixture HP 16192A.

Chip beads are 100% tested for impedance and dc resistance.